Product Specification

OLED Display Module

Jin Ma Ding	ID:	JMD1.3C
Ver: A		
Customer:		
Approved by		

From: Shenzhen Jin Ma Ding Electronics Co., Ltd

Approved by

Part Name:

Customer Part ID:

Notes:

- 1. Please contact Jin Ma Ding Electronics Co., Ltd. before assigning your product based on this module specification
- 2. The information contained herein is presented merely to indicate the characteristics and performance
 - of our products. No responsibility is assumed by Jin Ma Ding Electronics Co., Ltd for any intellectual property claims or other problems that may result from application based on the module described herein.

Revised History

Part Number	Revision	Revision Content	Revised on
JMD1.3C	А	New	2020-06-06

TABLE OF Contents

Pa	rt Nam	ne: OLED Display Module	1
1.	Basi	ic Specifications	5
	1.1	Display Specifications	5
	1.2	Mechanical Specifications	5
	1.3	Active Area / Memory Mapping & Pixel Construction	5
	1.4	Mechanical Drawing	6
	1.5	Pin Definition	7
	1.6	product picture	7
	1.7	Schematic Diagram	8
2.	Abs	solute Maximum Ratings	g
3.	Opt	tics & Electrical Characteristics	10
	3.1	Optics Characteristics	10
	3.2	DC Characteristics	10
	3.3	AC Characteristics	11
	3.3.	.1 SPI Interface Timing Characteristics:	11
4.	Fun	nctional Specification	13
	4.1	Commands	13
	4.2	VCC Generated by Internal DC/DC Circuit	14
5.	Reli	iability	18
	5.1	Contents of Reliability Tests	18
	5.2	Failure Check Standard	18
6.	Out	tgoing Quality Control Specifications	18
	6.1	Environment Required	18
	6.2	Sampling Plan	19
	6.3	Criteria & Acceptable Quality Level	19
	6.3.	.1 Cosmetic Check (Display Off) in Non-Active Area	19
	6.3.	.2 Cosmetic Check (Display Off) in Active Area	19
	6.3.	.3 Pattern Check (Display On) in Active Area	21
7.	Pred	cautions When Using These OEL Display Modules	22
	7.1	Handling Precautions	22

7.2	Storage Precautions	
	Designing Precautions	
	Precautions when disposing of the OEL display modules	
7.5	Other Precautions	24
Notice:		25

1. Basic Specifications

1.1 Display Specifications

1) Display Mode: Passive Matrix

2) Display Color: Monochrome (White)

3) Drive Duty: 1/64 Duty

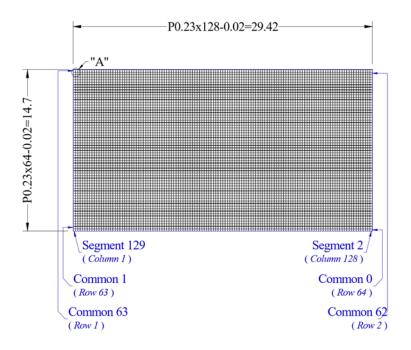
1.2 Mechanical Specifications

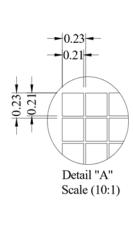
1) Outline Drawing: According to the annexed outline drawing

2) Number of Pixels: 128×64

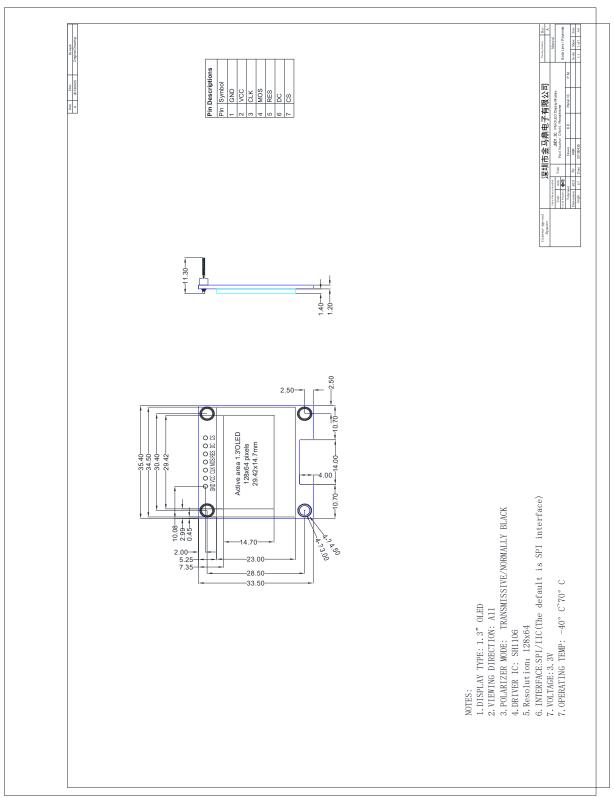
3) PCB Size: 35.4×33.5× 2.6 (mm)
 4) Active Area: 29.42 × 14.7 (mm)
 5) Pixel Pitch: 0.23 × 0.23 (mm)
 6) Pixel Size: 0.21 × 0.21 (mm)

1.3 Active Area / Memory Mapping & Pixel Construction





1.4 Mechanical Drawing



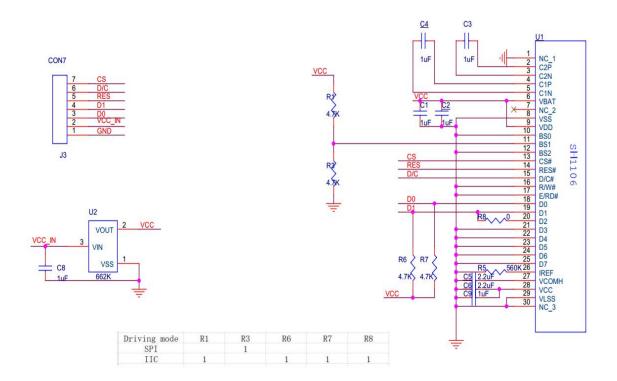
1.5 Pin Definition

PIN No.	Symbol	Description
1	GND	Ground of Logic Circuit
	01.12	This is a ground pin. It must be connected to ground
		Power Supply for OLED
2	VCC	This is a voltage supply pin. It must be connected to source
3	SCL	The serial clock input SCL
4	SDA	The serial data input SDA
		Power Reset for Controller and Driver
5	DEC	This pin is reset signal input. When the pin is low, initialization
Э	RES	of the chip is executed. Keep this pin pull high during normal
		operation
		Data/Command Control
6	DC	This pin is Data/Command control pin. When the pin is pulled high,
0	DC	the input at SDA is treated as display data. When the pin is pulled
		low, the input at SDA will be transferred to the command register.
7	CS	Chip Select
'	l CS	This pin is the chip select pin.Low enable, high disable.

1.6 product picture

Top view	Bottom view

1.7 Schematic Diagram



SPI Switch to IIC:

- 1. Change R3 to R1.
- 2. Ground DC pin and CS pin.
- 3. Use IIC program.

2. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Display	VCC	3	5	V	1, 2
Supply Voltage for Logic	SCL/SDA/RES/DC/CS	1.65	3.3	V	
Operating Temperature	Тор	-40	80	°C	
Storage Temperature	T _{STG}	-40	85	°C	3
Life Time (120 cd/m²)		10,000	-	hour	4
Life Time (80 cd/m²)		30,000	-	hour	4
Life Time (60 cd/m²)		50,000	-	hour	4

Note 1: All the above voltages are on the basis of "GND = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 3. "Optics & Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

Note 3: The defined temperature ranges do not include the polarizer. The maximum withstood temperature of the polarizer should be 80°C.

Note 4: VCC = 12 V, T_a = 25°C, 50% Checkerboard.

Software configuration follows Section 4.4 Initialization.

End of lifetime is specified as 50% of initial brightness reached. The average operating lifetime at room temperature is estimated by the accelerated operation at high temperature conditions.

3.Optics & Electrical Characteristics

3.1 Optics Characteristics

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Brightness (VCC Supplied Externally)	L _{br}	Note 5	120	-	-	cd/m²
Brightness (VCC Generated Internal DC/DC)	L _{br}	Note 6	100	150	-	cd/m²
C.I.E.	(x) (y)	C.I.E. 1931	0.28 0.31	0.32 0.35	0.36 0.39	
Dark Room Contrast	CR		-	2000:1	-	
Viewing Angle			-	Free	-	degree

^{*} Optical measurement taken at VDD = 2.8V, VCC = 12V & 7.25V. Software configuration follows Section 4.2 Initialization.

3.2DC Characteristics

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage for Logic	V_{DD}		1.65	2.8	3.3	٧
Supply Voltage for Display (Supplied Externally)	V _{CC}	Note 5 (Internal DC/DC Disable)	-	12	-	V
Supply Voltage for DC/DC	V_{BAT}	Internal DC/DC Enable	3.5	-	4.2	V
Supply Voltage for Display (Generated by Internal DC/DC)	V _{CC}	Note 6 (Internal DC/DC Enable)	6.4	-	9	V
High Level Input	V_{IH}	I _{OUT} = 100μA, 3.3MHz	0.8xV _{DD}	-	V_{DD}	V
Low Level Input	V _{IL}	I _{OUT} = 100μA, 3.3MHz	0	-	0.2xV _{DD}	V
High Level Output	V_{OH}	Ι _{ΟυΤ} = 100μΑ, 3.3MHz	0.9xV _{DD}	-	V_{DD}	V
Low Level Output	V_{OL}	I _{OUT} = 100μA, 3.3MHz	0	-	$0.1xV_{DD}$	V
Operating Current for VDD	I _{DD}		-	180	300	uA
Operating Current for VCC (VCC Supplied Externally)	I _{cc}	Note 7	-	23	32	mA
Operating Current for VBAT (VCC Generated by Internal DC/DC)	I _{BAT}	Note 8	-	45	50	mA
Sleep Mode Current for VDD	I _{DD,SLEEP}		-	1	5	uA
Sleep Mode Current for VCC	I _{CC,SLEEP}			2	10	uA

Note 5 & 6: Brightness (Lbr) and Supply Voltage for Display (VPP) are subject to the change of the panel characteristics and the customer's request.

Note 7: VDD = 2.8V, VCC = 12V, REF=910K,100% Display Area Turn on.

Note 8: VDD = 2.8V, VCC = 8V, REF=910K,100% Display Area Turn on.

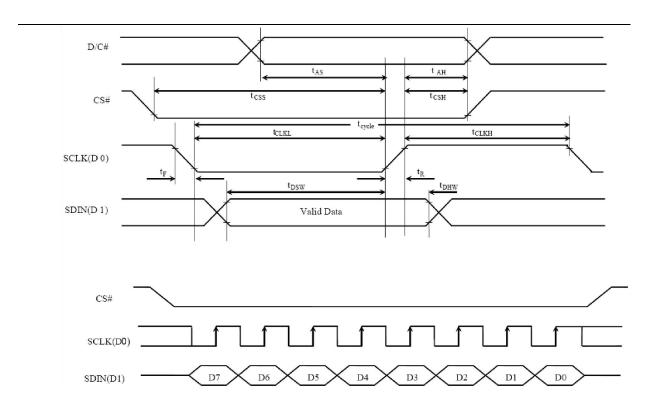
3.3AC Characteristics

3.3.1 SPI Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
t cycle	Clock Cycle Time	100	-	ns
t _{AS}	Address Setup Time	15	-	ns
t _{AH}	Address Hold Time	15	-	ns
t css	Chip Select Setup Time	20	-	ns
t csн	Chip Select Hold Time	10	-	ns
tosw	Write Data Setup Time	15	-	ns
tонw	Write Data Hold Time	15	-	ns
t clkl	Clock Low Time	20	-	ns
t clkh	Clock High Time	20	-	ns
t _R	Rise Time	-	40	ns
t _F	Fall Time	-	40	ns

^{*} $(V_{DD} - V_{SS} = 1.65 \text{V to } 3.3 \text{V}, T_a = 25 ^{\circ}\text{C})$

^{*} Software configuration follows Section 4.2 Initialization.

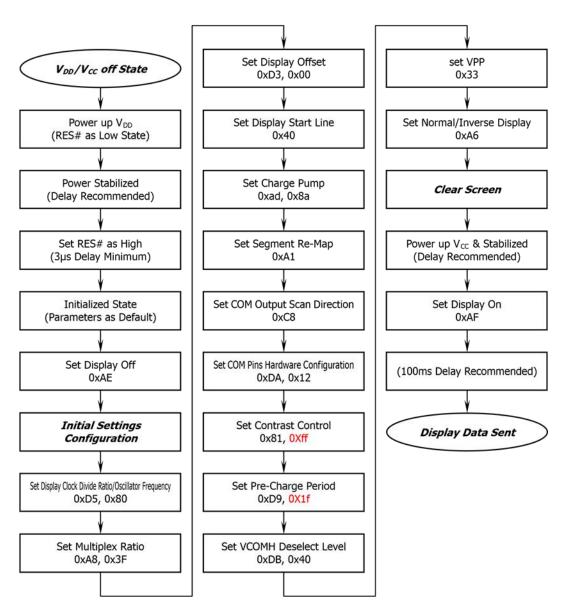


4. Functional Specification

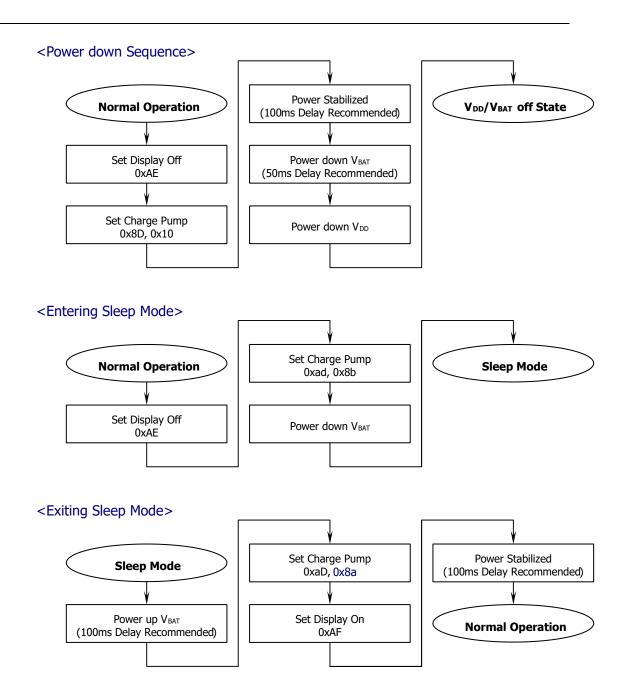
4.1Commands

D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description	Description		
0	81	1	0	0	0	0	0	0	1	Set Contrast Control	Double byte command to select 1 out of 25			
0	A[7:0]	A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		contrast ste	contrast steps. Contrast increases as the		
											value increa	ses.		
											(RESET = 7FI	h)		
0	DB	1	1	0	1	1	0	1	1	Set V _{COMH} Deselect	A[6:4]	Hex	V _{COMH} deselect level	
0	A[7:0	0	A ₆	A ₅	A ₄	0	0	0	0	Level		code		
"	A[7.0		Α 6	7.5	^4	"	"	"			000b	00h	~ 0.65 x V _{cc}	
]										010b	20h	~ 0.77 x V _{CC} (RESET)	
											011b	30h	~ 0.83 x V _{cc}	
0	A6/A7	1	0	1	0	0	1	1	X ₀	Set Normal/Inverse			l display (RESET) 0	
										Display			in display panel 1	
											in RAM: ON in display panel A7h, X[0]=1b: Inverse display			
											0 in RAM: ON in display panel 1 in RAM: OFF in display panel			
0	ΑE	1	0	1	0	1	1	1	X ₀	Set Display ON/OFF	AEh, X[0]=0b:Display OFF (sleep mode)			
	AF										(RESET)			
											AFh X[0]=1	o:Display	y ON in normal mode	
0	A0/A1	1	0	1	0	0	0	0	X ₀	Set Segment Re-map	A0h, X[0]=0	b: colur	nn address 0 is	
												•	SEGO (RESET)	
													nn address 127 is	
											mapp	oed to S	EG0	
0	C0/C8	1	1	0	0	X ₃	0	0	0	Set COM Output	C0h. X[3]=0	b: norm	al mode (RESET) Scan	
	'									Scan Direction	1		10 to COM[N –1]	
													pped mode. Scan	
													/[N-1] to COM0	
											Where N is			
													•	

4.2VCC Generated by Internal DC/DC Circuit



If the noise is accidentally occurred at the displaying window during the operation, please reset the display in order to recover the display function.



```
void OLED Init(void)
  //OLED 复位
  OLED RES Clr();//RES 置 0
   delay ms(200);//延时 200ms
   OLED RES Set();//RES 置 1
  //OLED 初始化
   OLED WR Byte(0xAE,OLED CMD); /*display off*/
   OLED WR Byte(0x02,OLED CMD); /*set lower column address*/
   OLED WR Byte(0x10,OLED CMD); /*set higher column address*/
   OLED WR Byte(0x40,OLED CMD); /*set display start line*/
   OLED WR Byte(0xB0,OLED CMD); /*set page address*/
   OLED_WR_Byte(0x81,OLED_CMD); /*contract control*/
   OLED WR Byte(0xcf,OLED CMD); /*128*/
   OLED WR Byte(0xA1,OLED CMD); /*set segment remap*/
   OLED_WR_Byte(0xA6,OLED_CMD); /*normal / reverse*/
   OLED WR Byte(0xA8,OLED CMD); /*multiplex ratio*/
   OLED WR Byte(0x3F,OLED CMD); /*duty = 1/64*/
   OLED WR Byte(0xad,OLED CMD); /*set charge pump enable*/
   OLED WR Byte(0x8b,OLED CMD); /* 0x8B 内供 VCC */
   OLED WR Byte(0x33,OLED CMD); /*0X30---0X33 set VPP 9V */
   OLED WR Byte(0xC8,OLED CMD); /*Com scan direction*/
   OLED WR Byte(0xD3,OLED CMD); /*set display offset*/
   OLED WR Byte(0x00,OLED CMD); /* 0x20 */
   OLED WR Byte(0xD5,OLED CMD); /*set osc division*/
   OLED WR Byte(0x80,OLED CMD);
   OLED WR Byte(0xD9,OLED CMD); /*set pre-charge period*/
   OLED WR Byte(0x1f,OLED CMD); /*0x22*/
   OLED_WR_Byte(0xDA,OLED_CMD); /*set COM pins*/
   OLED WR Byte(0x12,OLED CMD);
   OLED WR Byte(0xdb,OLED CMD); /*set vcomh*/
   OLED WR Byte(0x40,OLED CMD);
   OLED_Clear();
   OLED WR Byte(0xAF,OLED CMD); /*display ON*/
 }
```

```
#define OLED_CMD 0 //write command
#define OLED DATA 1 //write data
void OLED_WR_Byte(u8 dat,u8 cmd)
   u8 i;
   if(cmd)
     OLED_DC_Set();
   else
     OLED_DC_Clr();
   OLED CS Clr();
   for(i=0;i<8;i++)
   {
   OLED_SCL_Clr();
   if(dat&0x80)
       OLED_SDA_Set();
    else
       OLED_SDA_Clr();
   OLED_SCL_Set();
   dat<<=1;
   }
   OLED_CS_Set();
   OLED_DC_Set();
}
```

5. Reliability

5.1 Contents of Reliability Tests

ltem	Conditions	Criteria		
High Temperature Operation	70°C, 240 hrs			
Low Temperature Operation	-40°C, 240 hrs			
High Temperature Storage	85°C, 240 hrs	The operational		
Low Temperature Storage	-40°C, 240 hrs	functions work.		
High Temperature/Humidity Operation	60°C, 90% RH, 120 hrs			
Thermal Shock	-40°C ⇔ 85°C, 24 cycles 60 mins dwell			

^{*} The samples used for the above tests do not include polarizer.

5.2 Failure Check Standard

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at $23\pm5^{\circ}$ C; $55\pm15^{\circ}$ RH.

6. Outgoing Quality Control Specifications

6.1 Environment Required

Customer's test & measurement are required to be conducted under the following conditions:

Temperature: $23 \pm 5^{\circ}\text{C}$ Humidity: $55 \pm 15\% \text{ RH}$

Fluorescent Lamp: 30W

Distance between the Panel & Lamp: ≥ 50cm

Distance between the Panel & Eyes of the Inspector: ≥ 30cm

Finger glove (or finger cover) must be worn by the inspector.

Inspection table or jig must be anti-electrostatic.

^{*} No moisture condensation is observed during tests.

6.2Sampling Plan

Level II, Normal Inspection, Single Sampling, MIL-STD-105E

6.3 Criteria & Acceptable Quality Level

Partition	AQL	Definition	
Major	0.65	Defects in Pattern Check (Display On)	
Minor	1.0	Defects in Cosmetic Check (Display Off)	

6.3.1 Cosmetic Check (Display Off) in Non-Active Area

Check Item	Classification	Criteria
Panel General Chipping	Minor	X > 6 mm (Along with Edge) Y > 1 mm (Perpendicular to edge)

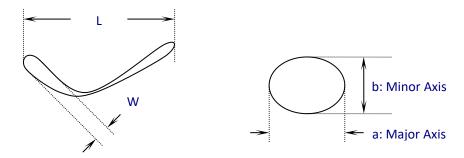
6.3.2 Cosmetic Check (Display Off) in Active Area

It is recommended to execute in clear room environment (class 10k) if actual in necessary.

Check Item	Classification	Criteria	
Any Dirt & Scratch on Polarizer's	Acceptable	Ignore for not Affect the Polarizer	
Protective Film			

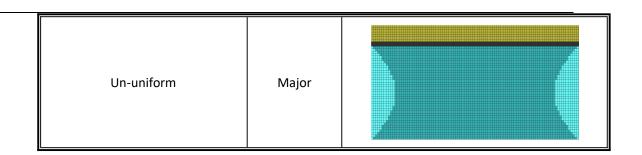
Scratches, Fiber, Line-Shape Defect (On Polarizer)	Minor	W ≤ 0.1 W > 0.1 L ≤ 2 L > 2	lgnore n ≤ 1 n = 0
Dirt, Black Spot, Foreign Material, (On Polarizer)	Minor	Φ ≤ 0.1 0.1 < Φ ≤ 0.25 0.25 < Φ	lgnore n ≤ 1 n = 0
Dent, Bubbles, White spot (Any Transparent Spot on Polarizer)	Minor	Φ ≤ 0.5 → Ignore if no Infl 0.5 < Φ	luence on Display n = 0
Fingerprint, Flow Mark (On Polarizer)	Minor	Not Allowable	

- * Protective film should not be tear off when cosmetic check.
- ** Definition of W & L & Φ (Unit: mm): Φ = (a + b) / 2



6.3.3 Pattern Check (Display On) in Active Area

Check Item	Classification	Criteria
No Display	Major	
Missing Line	Major	
Pixel Short	Major	
Darker Pixel	Major	
Wrong Display	Major	



7. Precautions When Using These OEL Display Modules

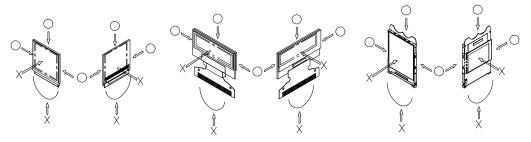
7.1 Handling Precautions

- 1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- 2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- 3) If pressure is applied to the display surface or its neighborhood of the OEL display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- 4) The polarizer covering the surface of the OEL display module is soft and easily scratched. Please be careful when handling the OEL display module.
- 5) When the surface of the polarizer of the OEL display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
 - * Scotch Mending Tape No. 810 or an equivalent

Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

Also, pay attention that the following liquid and solvent may spoil the polarizer:

- * Water
- * Ketone
- * Aromatic Solvents
- 6) Hold OEL display module very carefully when placing OEL display module into the system housing. Do not apply excessive stress or pressure to OEL display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- 7) Do not apply stress to the driver IC and the surrounding molded sections.
- 8) Do not disassemble nor modify the OEL display module.

- 9) Do not apply input signals while the logic power is off.
- 10) Pay sufficient attention to the working environments when handing OEL display modules to prevent occurrence of element breakage accidents by static electricity.
 - * Be sure to make human body grounding when handling OEL display modules.
 - * Be sure to ground tools to use or assembly such as soldering irons.
 - * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
 - * Protective film is being applied to the surface of the display panel of the OEL display module. Be careful since static electricity may be generated when exfoliating the protective film.
- 11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OEL display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).
- 12) If electric current is applied when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

7.2Storage Precautions

1) When storing OEL display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. and, also, avoiding high temperature and high humidity environment or low temperature (less than 0 ° C) environments. (We recommend you to store these modules in the packaged state when they were shipped from ZhongJingYuan technology Co.,Ltd.)

At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

2) If electric current is applied when water drops are adhering to the surface of the OEL display module, when the OEL display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

7.3 Designing Precautions

- 1) The absolute maximum ratings are the ratings which cannot be exceeded for OEL display module, and if these values are exceeded, panel damage may be happen.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the V_{IL} and V_{IH} specifications and, at the same time, to make the signal line cable as short as possible.
- We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (V_{DD}) . (Recommend value: 0.5A)
- 4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- 5) As for EMI, take necessary measures on the equipment side basically.
- 6) When fastening the OEL display module, fasten the external plastic housing section.

- 7) If power supply to the OEL display module is forcibly shut down by such errors as taking out the main battery while the OEL display panel is in operation, we cannot guarantee the quality of this OEL display module.
- 8) The electric potential to be connected to the rear face of the IC chip should be as follows: SSD1306
- * Connection (contact) to any other potential than the above may lead to rupture of the IC.

7.4 Precautions when disposing of the OEL display modules

1) Request the qualified companies to handle industrial wastes when disposing of the OEL display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

7.5 Other Precautions

- When an OEL display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.
 Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
- 2) To protect OEL display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OEL display modules.
 - * Pins and electrodes
 - * Pattern layouts such as the FPC
- 3) With this OEL display module, the OEL driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OEL driver is exposed to light, malfunctioning may occur.
- * Design the product and installation method so that the OEL driver may be shielded from light in actual usage.
- * Design the product and installation method so that the OEL driver may be shielded from light during the inspection processes.
 - 4) Although this OEL display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
 - 5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.

Warranty:

The warranty period shall last twelve (12) months from the date of delivery. Buyer shall be completed to assemble all the processes within the effective twelve (12) months. ZhongJingYuan technology Co.,Ltd. shall be liable for replacing any products which contain defective material or process which do not conform to the product specification, applicable drawings and specifications during the warranty period. All products must be preserved, handled and appearance to permit efficient handling during warranty period. The warranty coverage would be exclusive while the returned goods are out of the terms above.

Notice:

No part of this material may be reproduces or duplicated in any form or by any means without the written permission of ZhongJingYuan technology Co.,Ltd. ZhongJingYuan technology Co.,Ltd. reserves the right to make changes to this material without notice. ZhongJingYuan technology Co.,Ltd. does not assume any liability of any kind arising out of any inaccuracies contained in this material or due to its application or use in any product or circuit and, further, there is no representation that this material is applicable to products requiring high level reliability, such as, medical products. Moreover, no license to any intellectual property rights is granted by implication or otherwise, and there is no representation or warranty that anything made in accordance with this material will be free from any patent or copyright infringement of a third party. This material or portions thereof may contain technology or the subject relating to strategic products under the control of Foreign Exchange and Foreign Trade Law of Taiwan and may require an export license from the Ministry of International Trade and Industry or other approval from another government agency.